



# Product Change Notification

**Change Notification #:** 118068 - 00  
**Change Title:** Intel® Server System R1304WF0YSR,  
 Intel® Server System R2308WFTZSR ,  
 PCN 118068-00, Label,  
 Packaging Regulatory and Chassis Label  
 Update  
**Date of Publication:** January 26, 2021

## Key Characteristics of the Change: Label

### Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:*</b>	February 9, 2021
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

### Description of Change to the Customer:

Intel is updating the packaging and chassis regulatory labels of servers and chassis showed in "Products Affected" table below to replace NYCE logo by NOM and update NEMKO NTRL logo.

Figure 1. Chassis Label Before



Figure 2. Chassis Label - After



Figure 3. Outer Package Label – Before



Figure 4. Outer Package Label - After



### Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications.

### Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1304WFOYSR	986047	K39976-006	K39976-007
R2308WFTZSR	986052	K40014-008	K40014-009

### PCN Revision History:

**Date of Revision:**  
January 26, 2021

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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